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Product Specifications Approval Sheet

Product	Name: TCXO	SMD 2.0x1.6 40.00	DMHz
TST Par	t No.: TX0659E	≣	
Custome	er Part No.:		
Com	npany:		
Divis	sion:		
Арр	roved by:		
Date	9:		
			17
		Tom Liu	
Approve	d by:	Kelly Huang	Kelly Huang
Date:		07/13/2023	.]

- 1. Customer signed back is required before TST can proceed with sample build and receive orders.
- 2. Orders received without customer signed back will be regarded as agreement on the specifications.
- 3. Any specifications changes must be approved upon by both parties and a new revision of specifications shall be released to reflect the changes.



MODEL NO.: TX0659E REV. NO.: 2

Revise:

Rev.	Rev. Page	Rev. Account	Date	Ref. No.	Revised by
1	N/A	Initial release	12/15/20'	N/A	Tom Liu
2	4	Revise Base Pin#1:	07/13/23'	ECN-202300306	Tom Liu
		$Vc \rightarrow GND$			



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TCXO SMD 2.0x1.6 40.00MHz

MODEL NO.: TX0659E REV. NO.: 2

Features:

Ultra Miniature SMD Package

Good Frequency Stability

Good Phase Noise Response

Moisture Sensitivity Level (MSL): Level-1

AEC-Q200 compliance

RoHS Compliant Lead free Lead-free soldering

Description and Applications:

Surface mount 2.0mmx1.6mm TCXO for use in wireless communications devices

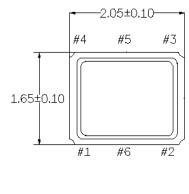
Electrical Specifications:

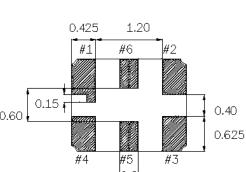
TX0659E	Specifications				
Nominal Frequency, Fo	40.000000 MHz				
Storage Temperature Range	-40°C to +105°C				
Operating Temperature Range	-40°C to +105°C				
Power Supply Voltage, Vcc	1.8 V+/- 5%				
Output Waveform	Clipped Sinewave				
Output Load	10pF//10KΩ				
Output Voltage with Load 10pF//10KΩ, Vout	0.8 Vp-p min				
Power Supply Current, Icc	2.0 mA max				
Frequency Tolerance after 2 relows	+/- 2.0 ppm max @ 25°C +/- 3°C				
Frequency Tolerance as received	+/- 1.0 ppm max @ 25°C +/- 2°C				
Frequency Stability a. Vs. Temperature (-40~85°C) Vs. Temperature (85~105°C) b. Vs. Load varied 10pF//10KΩ+/-10% c. Vs. Supply Voltage varied Vcc+/-5%	+/- 2.0 ppm reference to 25°C +/- 7.0 ppm reference to 25°C +/- 0.2 ppm +/- 0.2 ppm				
Start Up Time (90% of final RF level in Vp-p)	2.0 msec max.				
Aging	+/-1.0 ppm/year max @25°C first year				
Harmonics	-5.0 dBc max				

TST DCC Release document

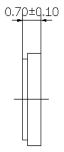
SSB Phase Noise (@1kHz Carrier Offset)	-130 dBc/Hz max
Marking	Laser marking

Mechanical Dimensions (mm):



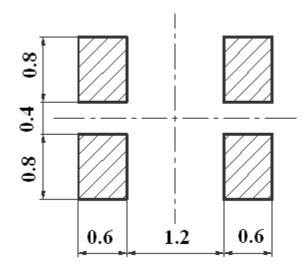


0.325



	Pin Connection			
#1	GND			
#2	GND			
#3	Output			
#4	+Vcc			
#5	No connect			
#6	No connect			

Recommended Land Pattern: (unit: mm)



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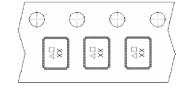
TST DCCRelease document

Marking:

Line 1: Frequency (40)

Line 2: Product Code : ☐ (☐ is TST internal tracking code) + Date Code of Year/Month : ▽

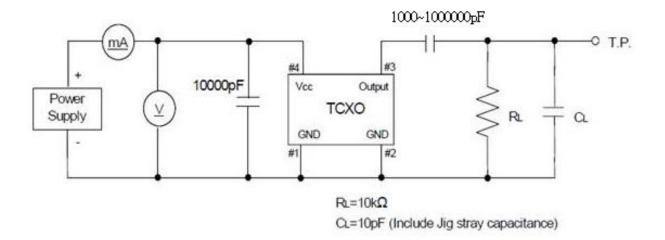




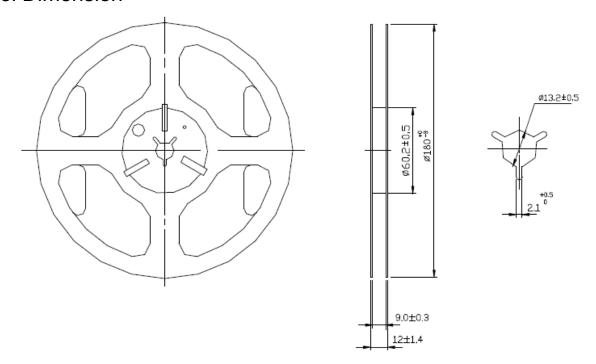
 ∇ : Date Code Table: Year/Month

Year/Month	1	2	3	4	5	6	7	8	9	10	11	12
2022	Α	В	С	D	Е	F	G	Н	J	K	L	М
2023	N	Р	Q	R	S	Т	U	V	W	Х	Υ	Z
2024	а	b	С	d	е	f	g	h	i	j	k	m
2025	n	р	q	r	s	t	u	V	w	х	у	Z

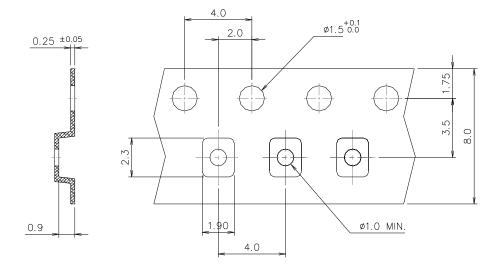
Recommended Circuit



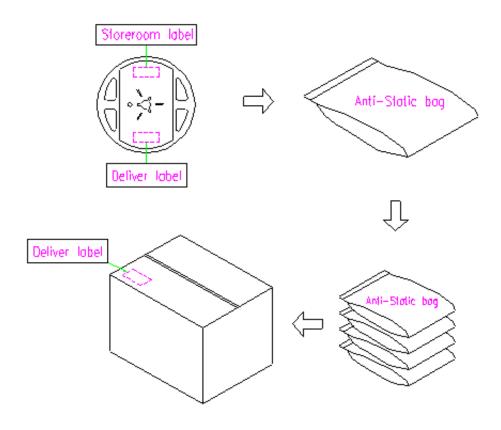
Reel Dimension



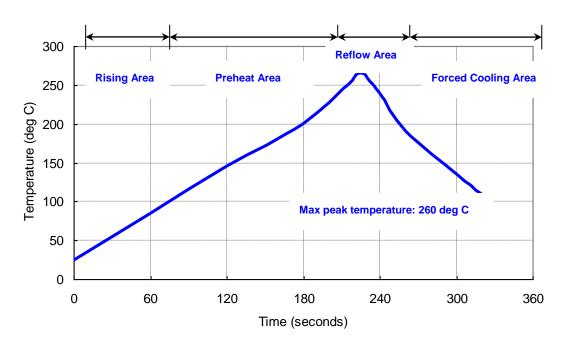
Tape Dimensions (mm)



Packing Quantity/Packing: 3K pcs maximum per reel



Reflow Profile:



Notes of the Usage:

- 1. Touch the solder iron at 260+/-5 deg C onto the leads for 10+/-2 sec max or touch the solder at 350+/-5 deg C onto the leads for 3+/-0.5 sec.
- 2. In the customer's reflow process, if it will remain some mechanical stress at the soldering terminals, also make some cracks on the soldering termination. Some cracks will cause open or short circuit and cause of thermal increasing or smoking. Don't make any excess mechanical stress to soldering points.
- 3. In case of giving a heavy shock to the products, it may make an open or short circuit and cause of thermal increasing and smoking. To avoid heavy shock impact applying to products is strictly required.
- 4. Ultrasonic cleaning should be avoided to prevent damage to the TCXO.
- Do Not Use Ultrasonic-Wave Soldering or Wave Solder with Package Immersed in Solder.

Notes of the Storage:

- 1. To keep products under the condition at the room temperature (-5~35 deg C) with normal humidity (45~75%). Absorption of moisture and dewdrop may make inferiority of characteristics and a short circuit.
- Oxidization of terminals shall make the solderability more inferior. Dusts and corrosive gas will make a cause of the open or short circuit. Keep it in the clean place where is not in dusty and no corrosive gas.
- 3. Use the unti-static material to the storage package.
- 4. Don't put any excess weight to the TCXO in the storage process.
- 5. Don't move the product from the cold place to the hot place in the short time, otherwise it may make some dew-drop, then a short circuit may happen in case.
- Storage periods should be maximum 6 months under condition of above item 1 after delivery from TST factory.
- 7. Once open the bag, there is possibility of electrical characteristics deterioration due to absorption of moisture. So, please use parts within 7 days after opening the bag.
- 8. If you have to keep parts without using after opening the bag, please put the drying agent in the bag, fold the bag and keep it in the place where temperature and humidity are controlled (nitrogen atmosphere box etc.)